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**CHIP-PACKAGING WITH BONDING OPTIONS CONNECTED TO A
PACKAGE SUBSTRATE**

Appl. No. : 10/709,428 Confirmation No. 3427
Applicant : Cheng-Yen Huang
Filed : May 5, 2004
TC/A.U. : 2814
Examiner : TRINH, HOA B
Docket No. : FTCP0035USA0
Customer No. : 27765

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT AND REQUEST FOR CONTINUED EXAMINATION

5 Sir:

In response to the Office action of May 2, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

10 Remarks/Arguments begin on page 5 of this paper.